

# Surface Mount Low Barrier X-Band Schottky Diodes

## MA4E1245 Series

V3.00

### Features

- Designed for High Volume Low Cost Detector and Mixer Applications
- Low Noise Figure: 5.7 dB (SSB) at X-Band
- High Detector Sensitivity: -55 dBm TSS
- Low Capacitance: 0.25 pF
- Fully Characterized Performance
- Single and Series Pair Configurations
- Available on Tape and Reel

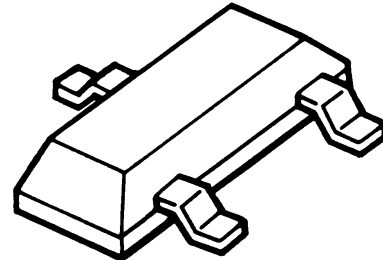
### Description

The MA4E1245 series is a low barrier n-type silicon Schottky diode assembled in a low cost surface mount plastic package. It is designed for service as a high performance mixer and detector diode at frequencies from VHF through X-band.

M/A-COM incorporated its HMIC technology in the MA4E1245 series allowing the use of pure glass in conjunction with an offset bond pad, to manufacture a low capacitance, low series resistance, Schottky diode chip. M/A-COM's high volume plastic packaging facility which is capable of manufacturing high quality microwave diode and transistor products is utilized in the production of these components. SPC controls are used during processing to ensure high quality.

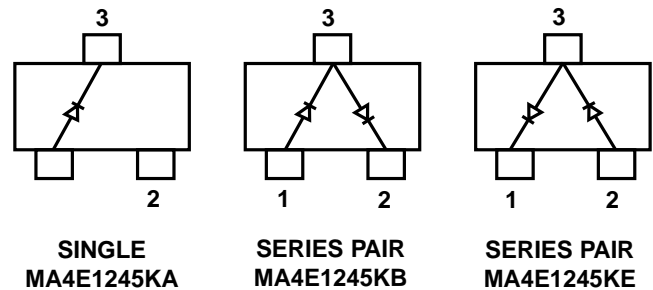
The MA4E1245KA is a single element Schottky diode characterized for use as a single ended mixer and detector. The MA4E1245KB and MA4E1245KE incorporate two Schottky chips in the SOT-23 package in series pair configurations. These devices are useful in balanced mixers and detector voltage doubler circuits. Applications for the MA4E1245 series include VSAT and DBS mixers and other frequency converters. Their small size and low cost make them attractive for use in RF tag applications for identification and toll collection.

### SOT-23



### Configurations

#### TOP VIEW



Specifications Subject to Change Without Notice.

**M/A-COM, Inc.**

North America: Tel. (800) 366-2266  
 Fax (800) 618-8883

■ Asia/Pacific: Tel. +81 (03) 3226-1671  
 Fax +81 (03) 3226-1451

■ Europe: Tel. +44 (1344) 869 595  
 Fax +44 (1344) 300 020

Maximum Ratings

Parameter	Unit	Values
Operating Temperature	°C	-65 to +125
Storage Temperature	°C	-65 to +125
Incident RF Power (CW)	mW	75°
Reverse Voltage @ 25°C	V	3
Soldering Temperature	°C	+260 for 5 sec.

\* At 25°C case temperature. Derate linearly to zero watts at 125°C case temperature.

Electrical Specifications @ 25°C

Parameter	Condition	Symbol	Specification
Breakdown Voltage	$I_R = 10 \mu A$	$V_B$	3.0 V min.
Total Capacitance	$V_R = 0$ $F = 1 \text{ MHz}$	$C_T$	0.25 pF max.
Capacitance Difference*	$V_R = 0$	$\Delta C_T$	0.04 pF max.
Dynamic Resistance	$I_F = 10 \text{ mA}$	$R_D$	14 Ohms max.
Dynamic Resistance Difference*	$I_F = 10 \text{ mA}$	$\Delta R_D$	2 Ohms max.
Forward Voltage	$I_F = 1 \text{ mA}$	$V_F$	250 mV min. 350 mV max.
Forward Voltage Difference*	$I_F = 1 \text{ mA}$	$\Delta V_F$	20 mV max.

\* Applies to MA4E1245KB and MA4E1245KE.

Typical RF Performance @ 25°C

Parameter	Typical Value	Conditions
Mixer Noise Figure <sup>1</sup>	5.7 dB (SSB)	$f = 9.375 \text{ GHz}$ $LO = 0 \text{ dBm}$
IF Impedance	200 Ohms	$I_F = 30 \text{ MHz}$
Tangential Signal Sensitivity <sup>2</sup>	-55 dBm	$I_F = 20 \mu A$ $BW = 2 \text{ MHz}$ Video NF = 1.5 dB
Detector Output Voltage at -30 dBm <sup>2</sup>	20 mV	$R_L = 100K \text{ Ohms}$ $I_F = 20 \mu A$
Detector Output Voltage at -30 dBm <sup>2</sup>	20 mV	$R_L = 1M \text{ Ohm}$ Zero Bias

Notes:

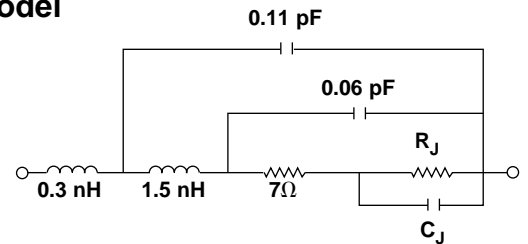
1. Fixture tuned to 9.375 GHz.
2. Fixture tuned to 2.5 GHz. See Figure 3 through Figure 6 for untuned fixture performance.

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Typical Scattering Parameters

Frequency (GHz)	0 dBm (Zero Bias) S11		-30 dBm (Zero Bias) S11		-30 dBm (20 $\mu A$ Bias) S11	
	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
1.00	0.56	-3.31	0.99	-9.88	0.97	-10.59
1.50	0.54	-13.76	0.99	-15.13	0.97	-15.91
2.00	0.52	-14.54	0.98	-19.94	0.96	-21.32
2.50	0.54	-17.80	0.98	-24.70	0.95	-27.12
3.00	0.50	-28.60	0.98	-29.79	0.95	-32.55
3.50	0.48	-35.04	0.98	-35.58	0.95	-39.21
4.00	0.48	-38.71	0.99	-41.97	0.95	-45.97
5.00	0.41	-54.30	0.97	-54.95	0.94	-60.45
6.00	0.33	-68.19	0.96	-69.62	0.92	-76.48
7.00	0.13	-103.79	0.95	-89.11	0.90	-97.46
8.00	0.07	148.85	0.91	-125.67	0.87	-123.48
9.00	0.20	89.00	0.90	-141.97	0.84	-157.67
10.00	0.29	63.62	0.88	178.71	0.81	158.60
11.00	0.41	51.93	0.87	140.49	0.83	120.07
12.00	0.48	38.25	0.86	99.44	0.82	81.04

Circuit Model



Circuit Model Values

RF Power	$R_J$ ( $\Omega$ )	$C_J$ (pF)
-30 dBm*	2500	0.090
-3 dBm	300	0.125
0 dBm	170	0.140
3 dBm	100	0.200

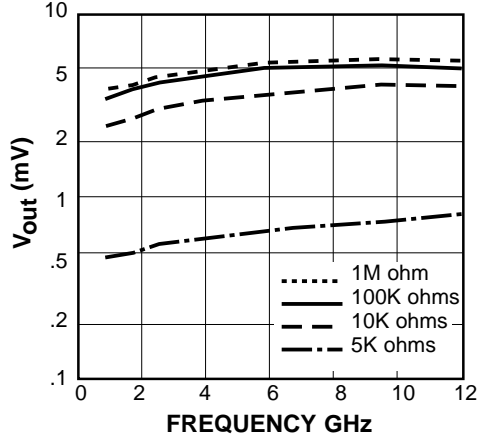
\*  $I_F = 20 \mu A$  at -30 dBm;  $I_F = 0$  at other power levels.

Spice Model Parameters

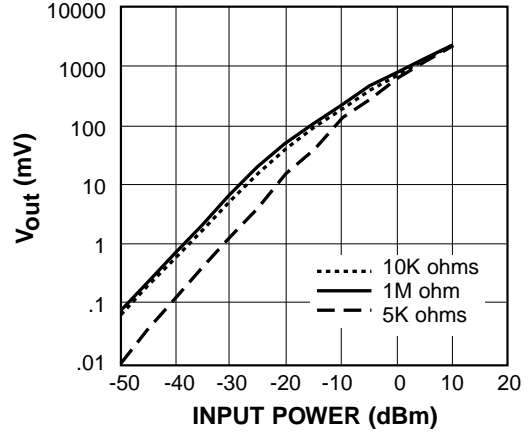
$IS = 3 \times 10^{-8} \text{ A}$	$M = 0.50$
$RS = 7 \Omega$	$EG = 0.69 \text{ eV}$
$N = 1.05$	$BV = 5.0 \text{ V}$
$TT = 0 \text{ S}$	$IBV = 1 \times 10^{-5} \text{ A}$
$CC = 0.08 \times 10^{-12} \text{ F}$	
$VJ = 0.85 \text{ V}$	

Typical Performance Curves @ 25°C  
(MA4E1245KE)

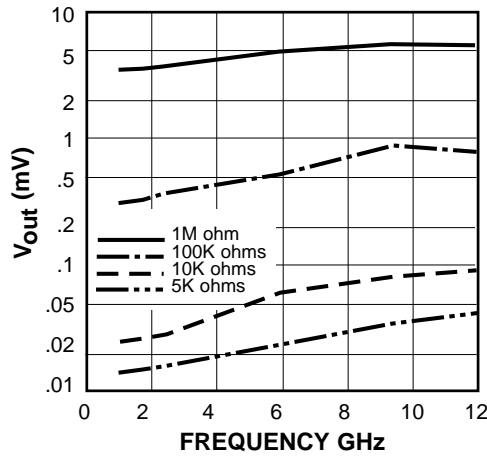
DETECTOR OUTPUT VOLTAGE vs FREQUENCY AND LOAD RESISTANCE AT -30 DBM. DIODE FORWARD BIASED AT 20 μA. UNTUNED FIXTURE.



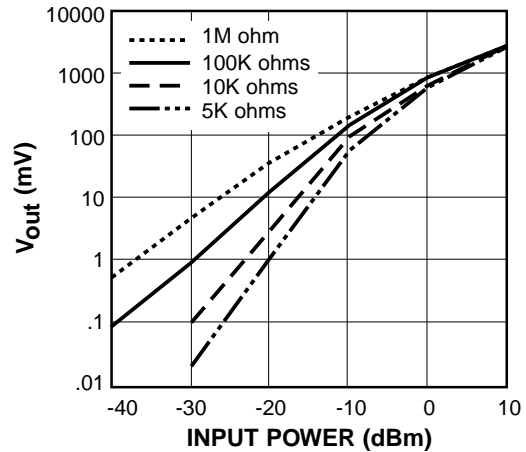
DETECTOR OUTPUT VOLTAGE vs INPUT POWER AND LOAD RESISTANCE. DIODE FORWARD BIASED AT 20 μA. UNTUNED FIXTURE AT 9.375 GHZ.



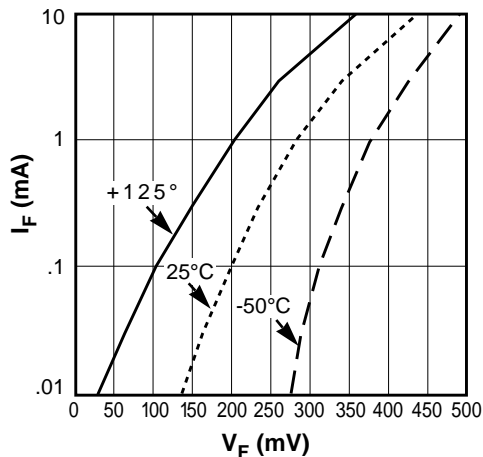
DETECTOR OUTPUT VOLTAGE vs FREQUENCY AND LOAD RESISTANCE AT -30 DBM. DIODE AT ZERO BIAS.



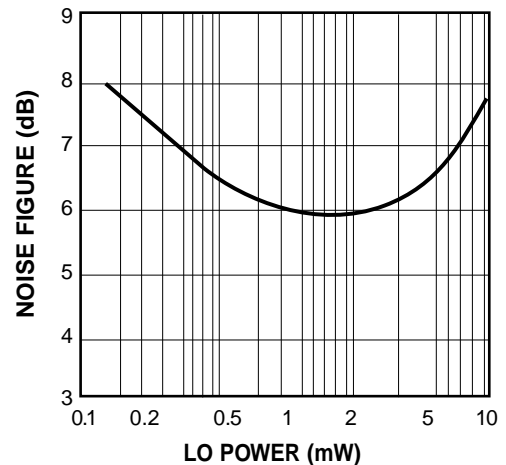
DETECTOR OUTPUT VOLTAGE vs INPUT POWER AND LOAD RESISTANCE. DIODE AT ZERO BIAS. UNTUNED FIXTURE AT 9.375 GHZ.



FORWARD CURRENT vs FORWARD VOLTAGE AND TEMPERATURE.

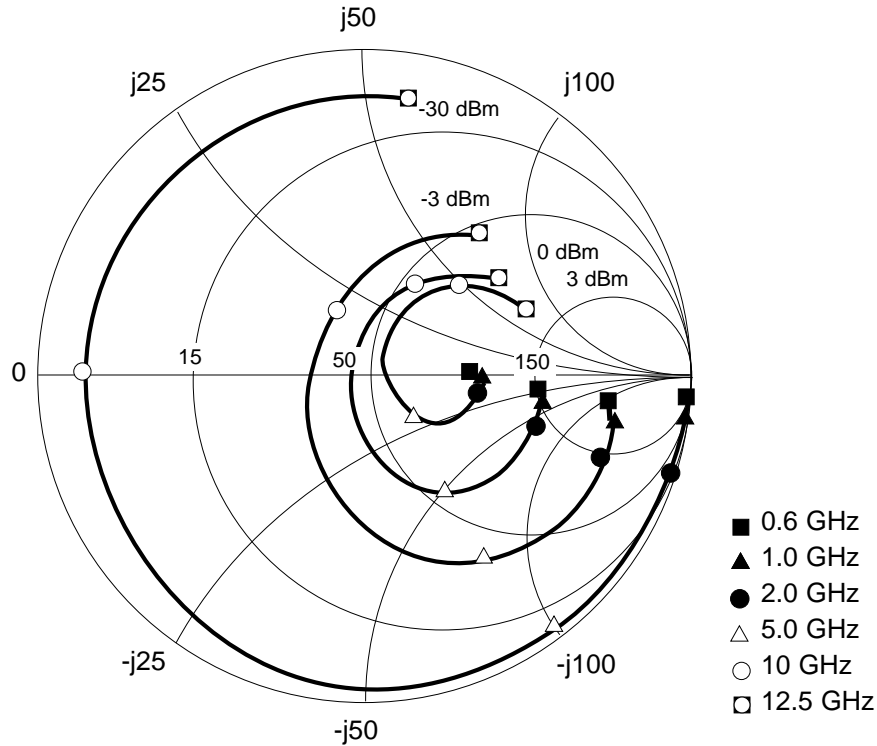


NOISE FIGURE vs LO POWER AT 9.375 GHZ.

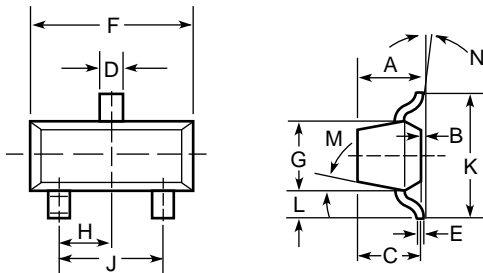


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RF Impedance of the MA4E1245KA



SOT-23 (High Profile)



DIM.	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
A	—	0.048	—	1,22
B	—	0.008	—	0,20
C	—	0.040	—	1,00
D	0.013	0.020	0,35	0,50
E	0.003	0.006	0,08	0,15
F	0.110	0.119	2,80	3,00
G	0.047	0.056	1,20	1,40
H	0.037 typical		0,95 typical	
J	0.075 typical		1,90 typical	
K	—	0.103	—	2,60
L	—	0.024	—	0,60

DIM.	GRADIENT
M	10° max.1
N	2°...30°

**Note:**  
1. Applicable on all sides

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